

Electronic Acknowledgement Receipt

EFS ID:	1051962
Application Number:	10530343
Confirmation Number:	7755
Title of Invention:	Trench insulation in substrate disks comprising logic semiconductors and power semiconductors
First Named Inventor:	Ralf Lerner
Customer Number:	21967
Filer:	Christopher J. Cuneo/Patricia Mast
Filer Authorized By:	Christopher J. Cuneo
Attorney Docket Number:	60291.0000034
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Application Type:	U.S. National Stage under 35 USC 371
International Application Number:	

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Submitted with Payment	no
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1		DOC003.PDF	2314753	yes	20

	Multipart Description		
	Doc Desc	Start	End
	Miscellaneous Incoming Letter	1	2
	Power of Attorney (may include Associate POA)	3	3
	Translation of Foreign Priority Documents	4	20

Warnings:

Information:

Total Files Size (in bytes):	2314753
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New Applications Under 35 U.S.C. 111
If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371
If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.